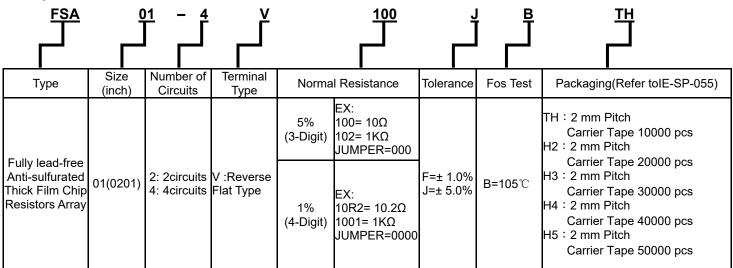


# 1 Scope:

- 1.1 This specification is applicable to fully lead-free and halogen-free FSA series reverse flat type thick film chip resistors array.
- 1.2 Fully lead-free products without RoHS exemptions
- 1.3 The product is for general electronic purpose.
- 1.4 Superior sulfur resistant capability (Refer to ASTM-B-809-95&EIA977 sulfur vapor test).

# 2 Explanation Of Part Numbers:



#### **3 Product Specifications:**

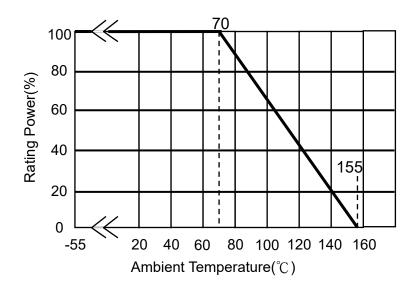
	Rated	Max.	Max.		<b>Resistance Range</b>	Number	Number	JUMPER	JUMPER
Туре	Power at 70℃	-	Overload Voltage	T.C.R. (ppm/°C)	F(±1%) J(±5%)	of Terminals	Of Resistors		Resistance Value
FSA01-2V (0201)	$\frac{1}{32}$ W	12.5V	25V	+400/-200	$10\Omega{\leq}R{\leq}100\Omega$	4	2	0.5A	100mΩ MAX.
				±250	$100\Omega \! < \! R \! \le \! 1M\Omega$				
FSA01-4V	1 🗤	1 W 12.5V	2.5V 25V	+400/-200	$10\Omega{\leq}R{\leq}100\Omega$	8	4	0.5A	100mΩ
(0201)	$\frac{1}{32}$ W	12.37	237	±250	$100\Omega \! < \! R \! \le \! 1M\Omega$	0	4	0.5A	MAX
Operating Temperature Range			− <b>55</b> °C ~ +155°C						



3.1 Power Derating Curve: Operating

Temperature Range : -55 ~ +155  $^\circ\!\mathrm{C}$ 

For resistors operated in ambient temperatures 70  $^\circ\!C$  , power rating shell be derated in accordance with the curve below:



#### 3.2 Rated Voltage:

3.2.1 Resistance Range:  $\geq\!1\Omega$ 

Rated Voltage: The resistor shall have a DC continuous working voltage or an rms. AC Continuous working voltage at commercial-line frequency and waveform corresponding to the power rating, as determined from the following:

 $E = \sqrt{R \times P}$   $R = Nominal resistance(\Omega)$ 

#### 3.2.2 Resistance Range: $(0\Omega)$

Rated Current: The resistor shall have a DC continuous working current or a rms.AC continuous working current at commercial-line frequency and wave form corresponding to the power rating, as determined from the following:

$$I=\sqrt{P/R}$$

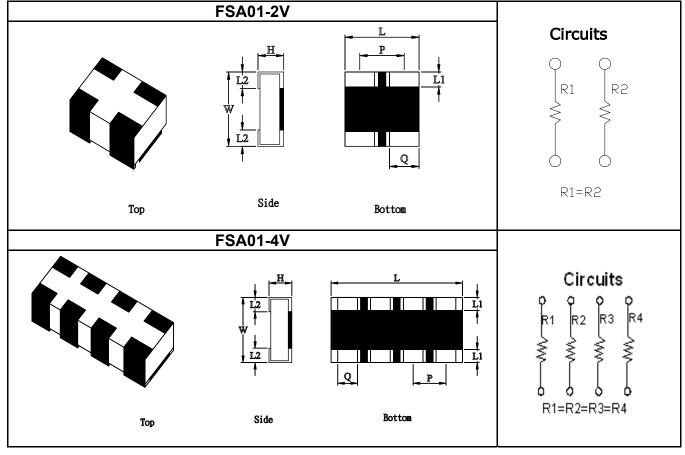
I= Rated current (A) P= Power rating (w) R= Nominal resistance(Ω)



## FSA Series Reverse Flat Type Thick Film Chip Resistors Array Product Specifications

IE-SP-211

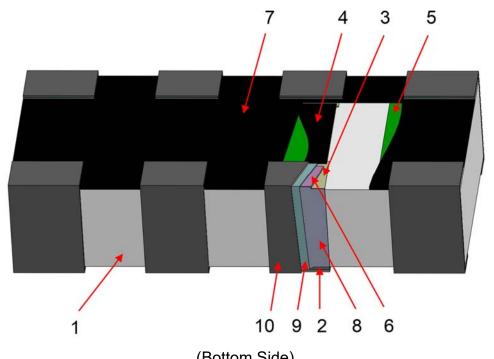
# **4** Physical Dimensions:



	Dimensions (mm)							
Туре	L	w	н	L1	L2	Р	Q	
FSA01-2V (0201)	0.80±0.05	0.60±0.05	0.23±0.10	0.20+0.05 -0.10	0.10+0.10 -0.05	0.50±0.05	0.20±0.10	
FSA01-4V (0201)	1.40±0.05	0.60±0.05	0.23±0.10	0.20+0.05 -0.10	0.10+0.10 -0.05	0.40±0.05	0.20±0.10	



# 5 Structure Graph:



	(8	Solitom Side)	
1	Ceramic substrate	6	2nd Bottom inner electrode
2	Top inner electrode	7	2ndProtective coating
3	Ist Bottom inner electrode	8	Terminal inner electrode
4	Resistive layer	9	Ni plating
5	1st Protective coating	10	Sn plating



# 6 Reliability Performance:

#### 6.1 Electrical Performance Test

ltere	Conditions	Specifications			
Item	Conditions	Resistors	Jumper		
Temperature Coefficient of Resistance	TCR (ppm/°C) = $\frac{(R2-R1)}{R1(T2-T1)}$ ×10 <sup>6</sup> R1: Resistance at room temperature R2: Resistance at -55°C or +125°C T1: Room temperature T2: Temperature -55°C or +125°C Refer to JIS-C5201-1 4.8	Refer item 3. General Specifications	NA		
Short Time Overload	Applied 2.5 times rated voltage for 5 seconds and release the load for about 30 minutes, then measure its resistance variance rate. (Rated voltage refer to item 3. general specifications) Refer to JIS-C5201-1 4.13		Refer to item 3. General Specifications		
Insulation Resistance	Put the resistor in the fixture, add 100 VDC in + ,- terminal for 60 sec then measured the insulation resistance between electrodes and insulating enclosure or between electrodes and base material. Refer to JIS-C5201-1 4.6				
Dielectric Withstand Voltage	Put the resistor in the fixture, add 300 VAC in +,- terminal for 60 sec. Refer to JIS-C5201-1 4.7	No short or burned on the appe	arance.		



# FSA Series Reverse Flat Type Thick Film Chip Resistors Array Product Specifications

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#### 6.2 Mechanical Performance Test

ltere	Conditions	Specifications			
Item	Conditions	Resistors	Jumper		
Resistance to	The tested resistor be immersed into isopropyl alcohol of $20\sim25^{\circ}$ for 5 minutes, then the resistor is left in the room for 48 hr, then measure its resistance variance rate. Refer to JIS-C5201-1 4.29	∆R=±1.0%	Refer to item 3. General Specifications		
Solderability	The resistor be immersed into solder pot in temperature $235\pm5^{\circ}$ for 2 sec, then the resistor is left as placed under microscope to observed its solder area. Refer to JIS-C5201-1 4.17	Solder coverage over 95%			
Resistance to Soldering Heat	<ul> <li>○ Test method 1 (solder pot test):</li> <li>The tested resistor be immersed into molten solder of 260+5/-0°C for 10 seconds. Then the resistor is left in the room for 1 hour.</li> <li>○ Test method 2 (solder pot test):</li> </ul>	<ul> <li>Test item 1:</li> <li>(1).Variance rate on resistance △R%=±1.0%</li> <li>Test item 2:</li> <li>(1).Solder coverage over 95%.</li> <li>(2).The underlying material (such as ceramic) shall not be visible at the crest corner area of the electrode.</li> </ul>	Refer to item 3. General Specifications		
Joint Strength of Solder	Sending Strength: Solder tested resistor on the PC board, add force in the middle down, and under load measure its resistance variance rate. D=3mm Resistor Testing circuit baord Ghlp resistor OHM Meter Refer to JIS-C5201-1 4.33	∆R%=±1.0%	Refer to item 3. General Specifications		



#### FSA Series Reverse Flat Type Thick Film Chip Resistors Array Product Specifications

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#### 6.3 Environmental Performance

Item	Conditio	20	Specifications		
nem			Resistors	Jumper	
Resistance to Dry Heat	Put tested resistors in chamber 155±5°C for 1,000±4 hours. T temperature for 60 minutes, an resistance variance rate. Refer to JIS-C5201-1 4.25	hen leaving in room	△R=±1.0%	Refer to item 3. General Specifications	
Thermal Shock	Put the tested resistor in the thermal shock chamber under the temperature cycle which shown in the following table shall be repeated 300 times consecutively. Then leaving the tested resistor in the room temperature for 1 hours, and measure its resistance variance rate.         Testing Condition         Lowest Temperature       -55±5°C         Highest Temperature       125±5°C         Temperature-retaining time       15 minutes each		∆R=±1.0%	Refer to item 3. General Specifications	
	Refer to MIL-STD 202 Method	107			
Loading Life in Moisture	Put the tested resistor in the c temperature 40±2°C, relative h load the rated voltage for 90 m off, total 1000 hours. Then lea in room temperature for 60 mi resistance variance rate. Refer to JIS-C5201-1 4.24	hamber under humidity 90~95% and hinutes on, 30 minutes ving the tested resistor nutes, and measure its	△R=±3.0%	Refer to item 3. General Specifications	
Load Life	Put the tested resistor in cham 70±2°C and load the rated vol 30 minutes off, total 1000 hou tested resistor in room temper and measure its resistance va Refer to JIS-C5201-1 4.25	tage for 90 minutes on, rs. Then leaving the ature for 60 minutes,	∆R=±3.0%	Refer to item 3. General Specifications	
Sulfuration Test			△R=±4.0%	Refer to item 3. General Specifications	

## 7 Plating Thickness:

7.1 Ni :  $\geq 2 \mu$  m 7.2 Sn(Tin) :  $\geq 3 \mu$  m 7.3 Sn(Tin) : Matte Sn

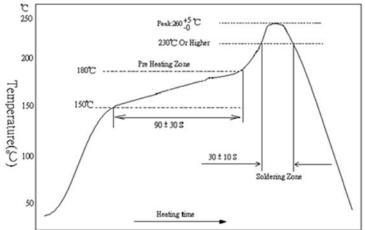
### 8 Rule of package empty quantity:

8.1 Empty quantity for each reels not allowed to exceed 0.1% of the whole quantity, and continuous 2pcs (included) empty are also unallowed.



# 9 Technical application notes: (This is for recommendation, please customer perform adjustment according to actual application)

- 9.1 Recommend Soldering Method:
  - 9.1.1 Lead Free Reflow Soldering Profile(MEET J-STD-020D)

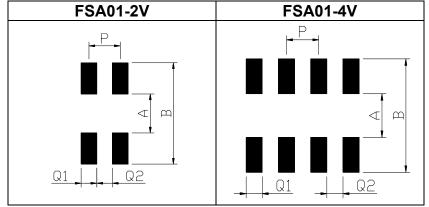


Remark: The peak temperature of soldering heat is 260 +5/-0  $^{\circ}$ C for 10 seconds.

9.1.2 Soldering Iron: temperature 350  $^\circ\!\mathrm{C}\pm10\,^\circ\!\mathrm{C}\,$  , dwell time shall be less than 3 sec.

#### 9.2 Recommend Land Pattern Design (For Reflow Soldering):

When a component is soldered, the resistance after soldering changes slightly depending on the size of the soldering area and the amount of soldering. When designing a circuit, it is necessary to consider the effect of a decrease or increase in its resistance.



Tune	Dimensions (mm)					
Туре	A	В	Р	Q1	Q2	
FSA01-2V	0.30	0.90	0.50	0.30	0.20	
FSA01-4V	0.30	0.90	0.40	0.20	0.20	



#### 9.3 Environment Precautions:

This specification product is for general electronic use, ABCO will not be responsible for any damage, cost or loss caused by using this specification product in any special environment. If other applications need to confirm with ABCO.

If consumer intends to use our Company product in special environment or condition (including but not limited to those mentioned below), then will need to make individual recognition of product features and reliability accordingly.

- (a) Used in high temperature and humidity environment
- (b) Exposed to sea breeze or other corrosive gas, such as Cl2 \ H2S \ NH3 \ SO2 and NO2.
- (c) Used in non-verified liquids including water, oil, chemical and organic solvents.
- (d) Using non-verified resin or other coating material to seal or coat our Company product.
- (e) After soldering, it is necessary to use water-soluble detergents to clean residual solder fluxes, even though no-clean fluxes are recommended.
- 9.4 Momentary Overload Precautions:

The product might be out of function when momentary overloaded. Please make sure to avoid momentary overloading while using and preserving.

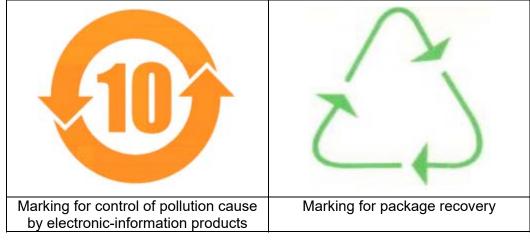
- 9.5 Operation and Processing Precautions:
  - (a) Avoid damage to the edge of resistor and protective layer caused by mechanical stress.
  - (b) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
  - (c) Make sure the power rating is under the limit when using the resistor. When power rating is over the limit, the resister will be overloaded. There might be machinery damage due to the climbing temperature.
  - (d) If the resister will be exposed under massive impact load (shock wave) in a short period of time, the working environment must be set up well before use.
  - (e) Please make evaluation and confirmation when the product is well used in your company and have a through consideration of it's fail-safe design to ensure the system safety.



# 10 Storage and transportation requirement:

- 10.1 The temperature condition must be controlled at  $25\pm5^{\circ}$ C, the R.H. must be controlled at  $60\pm15^{\circ}$ S. The stock can maintain quality level in two years.
- 10.2 Please avoid the mentioned harsh environment below when storing to ensure product performance and its' weldability. Places exposed to sea breeze or other corrosive gas, such as Cl2、H2S、NH3、SO2 and NO2.
- 10.3 When the product is moved and stored, please ensure the correct orientation of the box. Do not drop or squeeze the box. Otherwise, the electrode or the body of the product may be damaged.

# 11 The carton packaged for electronic-information products is made by the symbol as follows: (For china)





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